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*John J. Kelly, Jr.*

John J. Kelly, Jr.

Reg. No.: 29,182

Examiner : Alonzo Chambliss

Art Unit : 2827

Docket No.: 52433/544



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicants : K. TATSUMI et al.

Serial No. : 09/254,118

Filed : May 19, 1999

For : METHOD OF PARTIALLY PLATING SUBSTRATE FOR ELECTRONIC DEVICES

Commissioner for Patents  
Washington, D.C. 20231

**NOTICE OF APPEAL  
PURSUANT TO 37 C.F.R. §1.191**

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SIR:

Applicants hereby appeal to the Board of Patent Appeals and Interferences from the decision dated October 21, 2002 of the Primary Examiner finally rejecting claims 1-4, and 6-11 of the above-identified patent application.

- ☒ Please charge the fee of Three Hundred Twenty Dollars (\$320.00) for filing a Notice of Appeal to Deposit Account 11-0600. A duplicate of this paper is enclosed.
- ☒ Please charge any additional required fee or deficiency of fee associated with this appeal to Deposit Account 11-0600. A duplicate of this paper is enclosed.
- ☒ A petition for a three (3) month extension of time and deposit account authorization to cover the extension fee accompanies this Notice of Appeal.

Respectfully submitted,  
KENYON & KENYON

By: *John J. Kelly, Jr.*

John J. Kelly, Jr.

Reg. No. 29,182

Date: April 15, 2003  
KENYON & KENYON  
One Broadway  
New York, N.Y. 10004  
(212) 425-7200

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